Octal buffer/line driver; 3-state Rev. 12 — 16 September 2021

1. General description

The 74LVC244A; 74LVCH244A are 8-bit buffer/line drivers with 3-state outputs. The devices can be used as two 4-bit buffers or one 8-bit buffer. Both devices features two output enables $(1\overline{OE} \text{ and } 2\overline{OE})$, each controlling four of the 3-state outputs. A HIGH on $n\overline{OE}$ causes the outputs to assume a high-impedance OFF-state. Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V environments.

Schmitt-trigger action at all inputs makes the circuit tolerant of slower input rise and fall times.

This device is fully specified for partial power down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

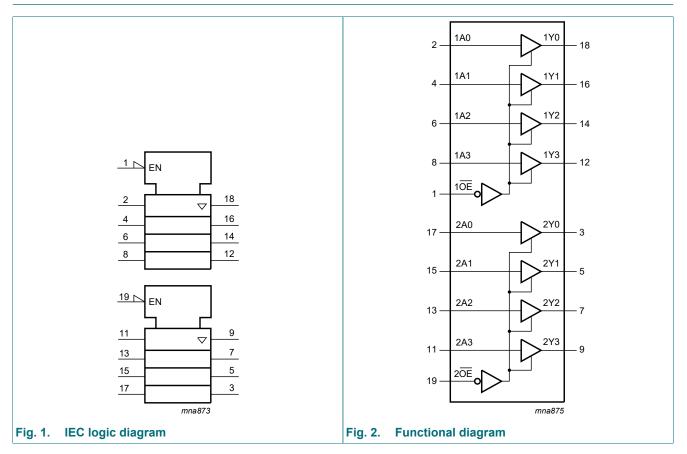
2. Features and benefits

- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low-power consumption
- Direct interface with TTL levels
- Overvoltage tolerant inputs to 5.5 V
- I_{OFF} circuitry provdes partial Power-down mode operation
- Bus hold on all data inputs (74LVCH244A only)
- Complies with JEDEC standard:
 - JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A (2.3 V to 2.7 V)
 - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

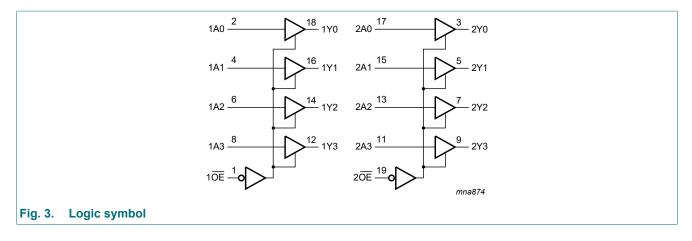
3. Ordering information

Type number	Package									
	Temperature range	Name	Description	Version						
74LVC244AD	-40 °C to +125 °C	SO20	plastic small outline package; 20 leads;	SOT163-1						
74LVCH244AD			body width 7.5 mm							
74LVC244APW	-40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads;	SOT360-1						
74LVCH244APW			body width 4.4 mm							
74LVC244ABQ	-40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal	SOT764-1						
74LVCH244ABQ			enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 × 4.5 × 0.85 mm							
74LVC244ABZ	-40 °C to +125 °C	DHXQFN20	plastic, leadless dual in-line compatible thermal enhanced extreme thin quad flat package; no leads; 20 terminals; 0.4 mm pitch; body 2 mm × 3.2 mm × 0.48 mm	SOT8020-1						

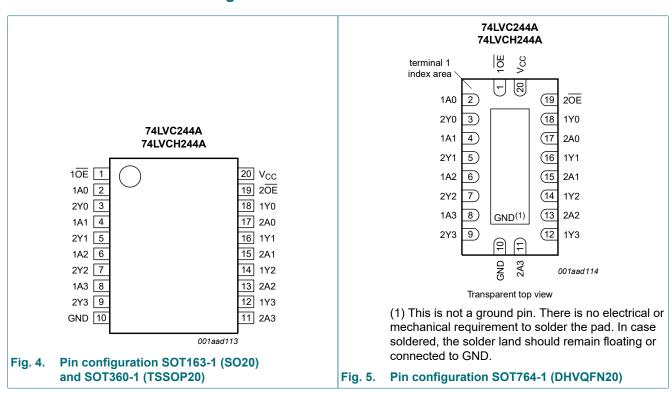
4. Functional diagram



Octal buffer/line driver; 3-state

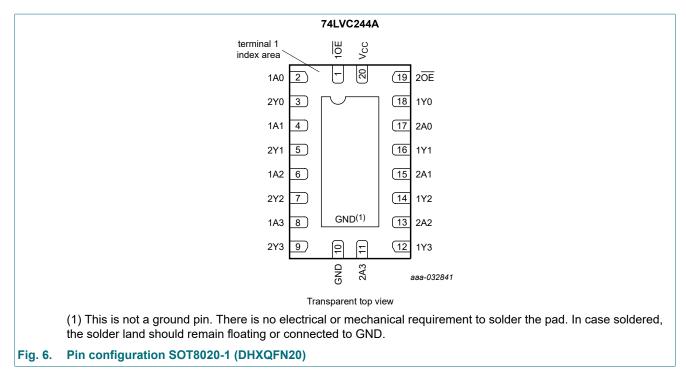


5. Pinning information



5.1. Pinning

Octal buffer/line driver; 3-state



5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
10E, 20E	1, 19	output enable input (active low)
1A0, 1A1, 1A2, 1A3	2, 4, 6, 8	data input
2Y0, 2Y1, 2Y2, 2Y3	3, 5, 7, 9	data output
GND	10	ground (0 V)
2A0, 2A1, 2A2, 2A3	17, 15, 13, 11	data input
1Y0, 1Y1, 1Y2, 1Y3,	18, 16, 14, 12	data output
V _{CC}	20	supply voltage

6. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

Control	Input	Output
nOE	nAn	nYn
L	L	L
L	Н	Н
Н	x	Z

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V		-50	-	mA
VI	input voltage		[1]	-0.5	+6.5	V
I _{OK}	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V		-	±50	mA
Vo	output voltage	output HIGH or LOW	[2]	-0.5	V _{CC} + 0.5	V
		output 3-state	[2]	-0.5	+6.5	V
I _O	output current	$V_{O} = 0 V \text{ to } V_{CC}$		-	±50	mA
I _{CC}	supply current			-	100	mA
I _{GND}	ground current			-100	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	T _{amb} = -40 °C to +125 °C				
		SOT163-1; SOT360-1; SOT764-1	[3]	-	500	mW
		SOT8020-1		-	250	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SOT163-1 (SO20) package: P_{tot} derates linearly with 12.3 mW/K above 109 °C.

For SOT360-1 (TSSOP20) package: P_{tot} derates linearly with 10.0 mW/K above 100 °C.

For SOT764-1 (DHVQFN20) package: P_{tot} derates linearly with 12.9 mW/K above 111 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	3.6	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW	0	-	V _{CC}	V
		output 3-state	0	-	5.5	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 1.2 V to 2.7 V	0	-	20	ns/V
		V _{CC} = 2.7 V to 3.6 V	0	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40 °C		°C to +85	S°C	-40 °C to +125 °C		Unit
				Min	Тур [1]	Мах	Min	Мах	1
V _{IH}	HIGH-level input	V _{CC} = 1.2 V		1.08	-	-	1.08	-	V
	voltage	V _{CC} = 1.65 V to 1.95 V		0.65V _{CC}	-	-	0.65V _{CC}	-	V
		V _{CC} = 2.3 V to 2.7 V		1.7	-	-	1.7	-	V
		V _{CC} = 2.7 V to 3.6 V	_{CC} = 2.7 V to 3.6 V		-	-	2.0	-	V
V _{IL}	LOW-level input	V _{CC} = 1.2 V		-	-	0.12	-	0.12	V
	voltage	V _{CC} = 1.65 V to 1.95 V		-	-	0.35V _{CC}	-	0.35V _{CC}	V
		V _{CC} = 2.3 V to 2.7 V		-	-	0.7	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V		-	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$							
	output voltage	I _O = -100 μA; V _{CC} = 1.65 V to 3.6 V		V _{CC} - 0.2	-	-	V _{CC} - 0.3	-	V
		I _O = -4 mA; V _{CC} = 1.65 V		1.2	-	-	1.05	-	V
		I _O = -8 mA; V _{CC} = 2.3 V		1.8	-	-	1.65	-	V
		I _O = -12 mA; V _{CC} = 2.7 V		2.2	-	-	2.05	-	V
		I _O = -18 mA; V _{CC} = 3.0 V		2.4	-	-	2.25	-	V
		I_0 = -24 mA; V_{CC} = 3.0 V		2.2	-	-	2.0	-	V
V _{OL}	LOW-level output	V _I = V _{IH} or V _{IL}							
	voltage	I _O = 100 μA; V _{CC} = 1.65 V to 3.6 V		-	-	0.2	-	0.3	V
		I _O = 4 mA; V _{CC} = 1.65 V		-	-	0.45	-	0.65	V
		I _O = 8 mA; V _{CC} = 2.3 V		-	-	0.6	-	0.8	V
		I _O = 12 mA; V _{CC} = 2.7 V		-	-	0.4	-	0.6	V
		I _O = 24 mA; V _{CC} = 3.0 V		-	-	0.55	-	0.8	V
I	input leakage current	V _I = 5.5 V or GND; V _{CC} = 3.6 V	[2]	-	±0.1	±5	-	±20	μA
I _{OZ}	OFF-state output current	V _I = V _{IH} or V _{IL} ; V _O = 5.5 V or GND; V _{CC} = 3.6 V	[2]	-	±0.1	±5	-	±20	μA
I _{OFF}	power-off leakage current	$V_{\rm I}$ or $V_{\rm O}$ = 5.5 V; $V_{\rm CC}$ = 0.0 V		-	±0.1	±10	-	±20	μA
I _{CC}	supply current	V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 3.6 V		-	0.1	10	-	40	μA
ΔI _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 0.6 V$; $I_O = 0 A$; $V_{CC} = 2.7 V$ to 3.6 V		-	5	500	-	5000	μA
Cı	input capacitance			-	4.0	-	-	-	pF

Octal buffer/line driver; 3-state

Symbol	Parameter	Conditions		-40	°C to +85	°C	-40 °C to +125 °C		Unit
			Min	Typ [1]	Мах	Min	Max	1	
I _{BHL}	bus hold LOW	V _{CC} = 1.65 V; V _I = 0.58 V	[3][4]	10	-	-	10	-	μA
	current	V _{CC} = 2.3 V; V _I = 0.7 V		30	-	-	25	-	μA
		V _{CC} = 3.0 V; V _I = 0.8 V		75	-	-	60	-	μA
I _{BHH}	bus hold HIGH	V _{CC} = 1.65 V; V _I = 1.07 V	[3][4]	-10	-	-	-10	-	μA
current	V _{CC} = 2.3 V; V _I = 1.7 V		-30	-	-	-25	-	μA	
		V _{CC} = 3.0 V; V _I = 2.0 V		-75	-	-	-60	-	μA
I _{BHLO}	bus hold LOW	V _{CC} = 1.95 V	[3][5]	200	-	-	200	-	μA
	overdrive current	V _{CC} = 2.7 V		300	-	-	300	-	μA
		V _{CC} = 3.6 V		500	-	-	500	-	μA
I _{BHHO}	bus hold HIGH	V _{CC} = 1.95 V	[3][5]	-200	-	-	-200	-	μA
	overdrive current	V _{CC} = 2.7 V		-300	-	-	-300	-	μA
		V _{CC} = 3.6 V		-500	-	-	-500	-	μA

[1] [2]

All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C. The bus hold circuit is switched off when $V_I > V_{CC}$ allowing 5.5 V on the input terminal. Valid for data inputs of bus hold parts only (74LVCH244A). Note that control inputs do not have a bus hold circuit. [3]

[4] The specified sustaining current at the data input holds the input below the specified V₁ level.

The specified overdrive current at the data input forces the data input to the opposite input state. [5]

74LVC_LVCH244A

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Fig. 9.

Symbol	Parameter	Conditions		0 °C to +85	°C	-40 °C to	Unit	
			Min	Тур [1]	Max	Min	Max	1
t _{pd} propagation delay		nAn to nYn; see <u>Fig. 7</u> [2]						
		V _{CC} = 1.2 V	-	17.0	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V	1.5	6.4	13.7	1.5	15.8	ns
		V _{CC} = 2.3 V to 2.7 V	1.0	3.4	7.1	1.0	8.2	ns
		V _{CC} = 2.7 V	1.5	3.4	6.9	1.5	9.0	ns
		V _{CC} = 3.0 V to 3.6 V	1.5	2.9	5.9	1.5	7.5	ns
t _{en}	enable time	nOE to nYn; see Fig. 8 [2]						
		V _{CC} = 1.2 V	-	24.0	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V	1.5	7.0	17.3	1.5	20.0	ns
		V _{CC} = 2.3 V to 2.7 V	1.5	3.9	9.5	1.5	11.0	ns
		V _{CC} = 2.7 V	1.5	4.1	8.6	1.5	11.0	ns
		V _{CC} = 3.0 V to 3.6 V	1.0	3.2	7.6	1.0	9.5	ns
t _{dis}	disable time	nOE to nYn; see Fig. 8 [2]						
		V _{CC} = 1.2 V	-	9.0	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V	2.2	4.5	9.8	2.2	11.3	ns
		V _{CC} = 2.3 V to 2.7 V	0.5	3.6	5.5	0.5	6.4	ns
		V _{CC} = 2.7 V	1.5	3.3	6.8	1.5	8.5	ns
		V _{CC} = 3.0 V to 3.6 V	1.5	3.1	5.8	1.5	7.5	ns
t _{sk(o)}	output skew time	[3]	-	-	1.0	-	1.5	ns
C _{PD}	power dissipation	per input; V_I = GND to V_{CC} [4]						
	capacitance	V _{CC} = 1.65 V to 1.95 V	-	6.4	-	-	-	pF
		V _{CC} = 2.3 V to 2.7 V	-	9.6	-	-	-	pF
		V _{CC} = 3.0 V to 3.6 V	-	12.5	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

 t_{pd} is the same as t_{PLH} and t_{PHL} . [2] $t_{en} \mbox{ is the same as } t_{PZL} \mbox{ and } t_{PZH}.$ t_{dis} is the same as t_{PLZ} and $t_{\text{PHZ}}.$

Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design. [3]

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W). $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where:

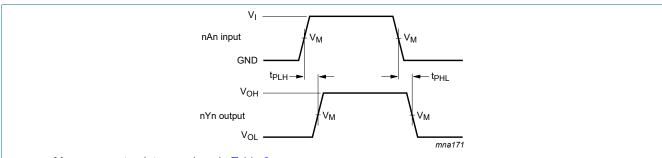
 f_i = input frequency in MHz; f_o = output frequency in MHz

C_L = output load capacitance in pF

V_{CC} = supply voltage in Volts

N = number of inputs switching $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

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10.1. Waveforms and test circuit

Measurement points are given in <u>Table 8</u>.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 7. The input (nAn) to output (nYn) propagation delays

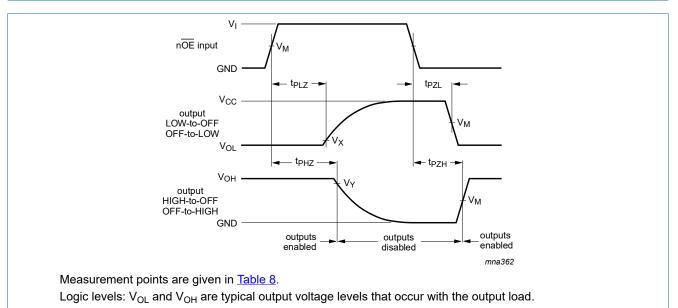
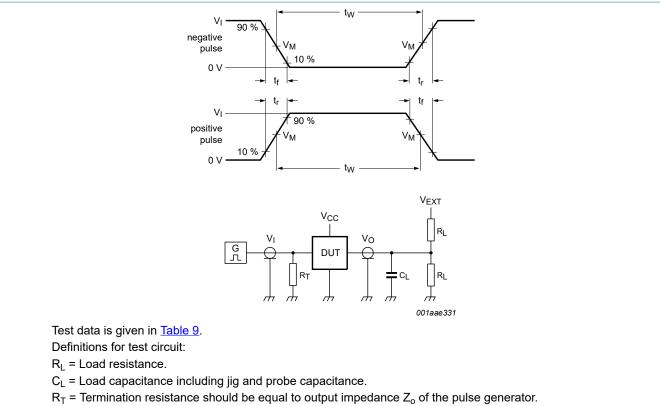


Fig. 8. 3-state enable and disable times

Table 8. Measurement points

Supply voltage	Input		Output	Output				
V _{cc}	VI	V _M	V _M	V _X	V _Y			
1.2 V	V _{CC}	0.5 × V _{CC}	$0.5 \times V_{CC}$	V _{OL} + 0.15 V	V _{OH} - 0.15 V			
1.65 V to 1.95 V	V _{CC}	0.5 × V _{CC}	$0.5 \times V_{CC}$	V _{OL} + 0.15 V	V _{OH} - 0.15 V			
2.3 V to 2.7 V	V _{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	V _{OL} + 0.15 V	V _{OH} - 0.15 V			
2.7 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} - 0.3 V			
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} - 0.3 V			

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V_{EXT} = External voltage for measuring switching times.

Fig. 9. Test circuit for measuring switching times

Table 9. Test data

Supply voltage	Input		Load	Load		V _{EXT}		
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}	
1.2 V	V _{CC}	≤ 2 ns	30 pF	1 kΩ	open	2 × V _{CC}	GND	
1.65 V to 1.95 V	V _{CC}	≤ 2 ns	30 pF	1 kΩ	open	2 × V _{CC}	GND	
2.3 V to 2.7 V	V _{CC}	≤ 2 ns	30 pF	500 Ω	open	$2 \times V_{CC}$	GND	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	2 × V _{CC}	GND	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	$2 \times V_{CC}$	GND	

Octal buffer/line driver; 3-state

11. Package outline

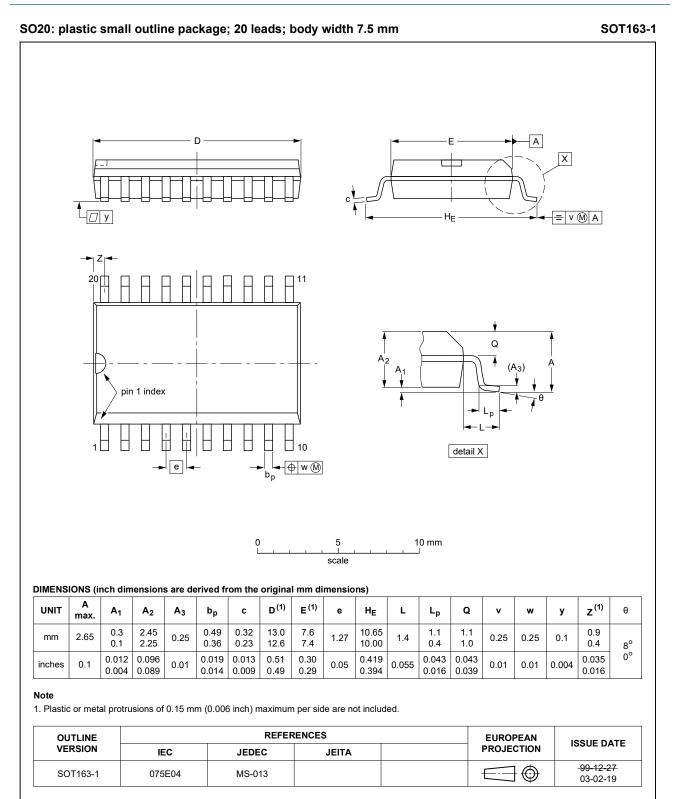


Fig. 10. Package outline SOT163-1 (SO20)

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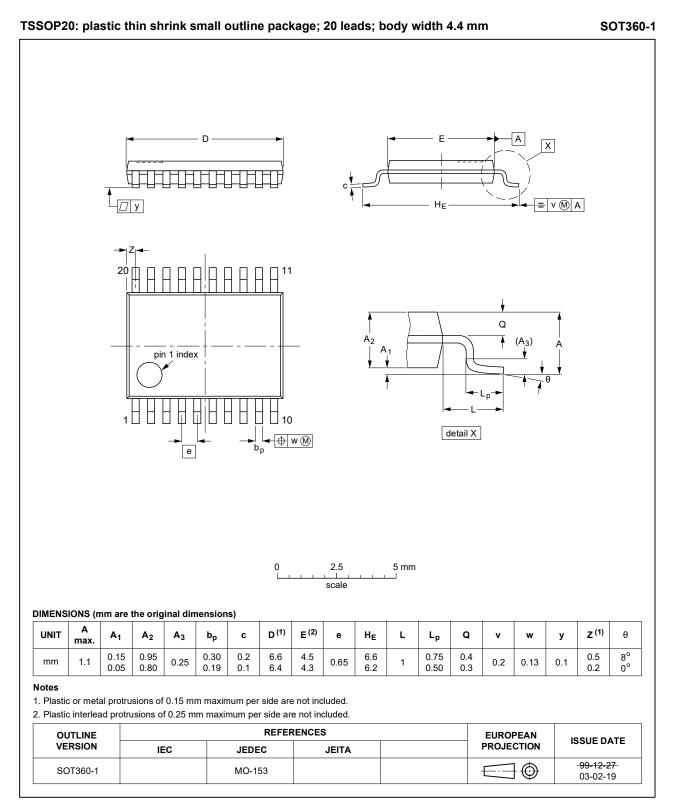


Fig. 11. Package outline SOT360-1 (TSSOP20)

Octal buffer/line driver; 3-state

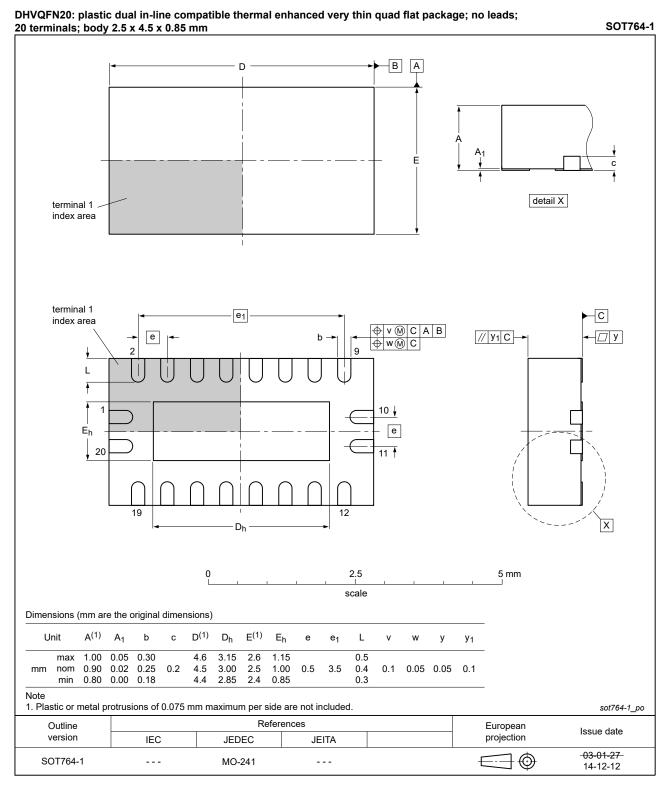
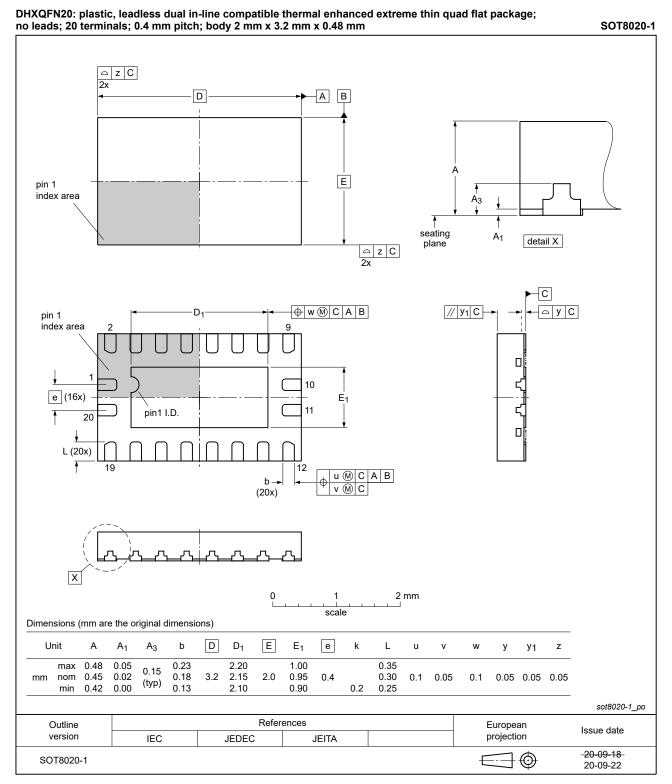


Fig. 12. Package outline SOT764-1 (DHVQFN20)

Octal buffer/line driver; 3-state





12. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC_LVCH244A v.12	20210916	Product data sheet	-	74LVC_LVCH244A v.11
Modifications:	21	er 74LVC244ADB (SO nd <u>Section 2</u> updated.	T339-1 / SSOP20) removed.
74LVC_LVCH244A v.11	20210429	Product data sheet	-	74LVC_LVCH244A v.10
Modifications:		er 74LVC244ABZ (SOT er 74LVCH244ADB (SO		
74LVC_LVCH244A v.10	20200408	Product data sheet	-	74LVC_LVCH244A v.9
Modifications:	• <u>Table 4</u> : De	rating values for P _{tot} to	tal power dissipat	ion updated.
74LVC_LVCH244A v.9	20180813	Product data sheet	-	74LVC_LVCH244A v.8
Modifications:	guidelinesLegal texts	of Nexperia. have been adapted to	the new company	o comply with the identity name where appropriate. (SOT1045-2) removed.
74LVC_LVCH244A v.8	20130626	Product data sheet	-	74LVC_LVCH244A v.7
Modifications:		mbers 74LVC244ABX ed to DHXQFN20 (SOT		BX DHXQFN20U (SOT1045-1
74LVC_LVCH244A v.7	20111122	Product data sheet	-	74LVC_LVCH244A v.6
Modifications:	guidelinesLegal texts	of NXP Semiconductors have been adapted to <u>ble 5, Table 6, Table 7</u> ,	s. the new company	o comply with the new identity name where appropriate. 9: values added for lower
74LVC_LVCH244A v.6	20090813	Product data sheet	-	74LVC_LVCH244A v.5
74LVC_LVCH244A v.5	20090709	Product data sheet	-	74LVC_LVCH244A v.4
74LVC_LVCH244A v.4	20031030	Product specification	-	74LVC_LVCH244A v.3
74LVC_LVCH244A v.3	20030520	Product specification	-	74LVC_H244A v.2
74LVC H244A v.2	19980520	Product specification	-	74LVC244A_74LVCH244A v.1
		-		

74LVC_LVCH244A

Octal buffer/line driver; 3-state

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at

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Octal buffer/line driver; 3-state

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